

RoHS Compliant Product
A suffix of "C" specifies halogen & lead-free

FEATURES

- Glass Passivated Chip Junction
- High Surge Current Capability
- Designed for Surface Mount Application

MECHANICAL DATA

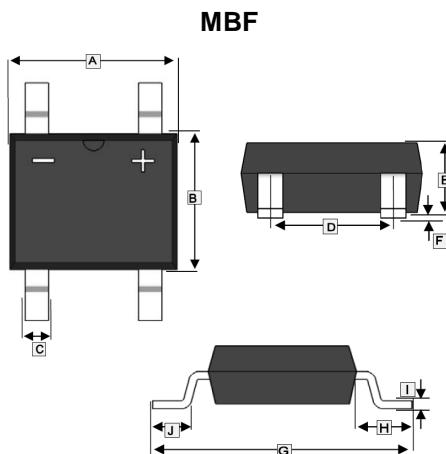
- Case: MBF
- Terminals: Solderable per MIL-STD-750, Method 2026
- Mounting position: Any

MARKING

12M10

PACKAGE INFORMATION

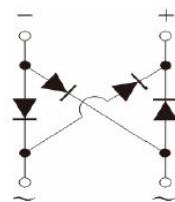
Package	MPQ	Leader Size
MBF	5K	13 inch



REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	4.5	5.0	F	0.2	TYP.
B	3.6	4.1	G	6.4	7.0
C	0.5	0.8	H	1.3	1.7
D	2.3	2.7	I	0.15	0.22
E	1.2	1.6	J	0.5	1.1

ORDER INFORMATION

Part Number	Type
MB121F-C~MB1210F-C	Lead (Pb)-free and Halogen-free



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(Rating 25°C ambient temperature unless otherwise specified. Single phase half wave, 60Hz, resistive or inductive load.
For capacitive load, de-rate current by 20%.)

Parameter	Symbol	Part Number						Unit
		MB 121F-C	MB 122F-C	MB 124F-C	MB 126F-C	MB 128F-C	MB 1210F-C	
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	100	200	400	600	800	1000	V
Maximum RMS Voltage	V _{RMS}	70	140	280	420	560	700	
Maximum DC Blocking Voltage	V _{DC}	100	200	400	600	800	1000	
Maximum Average Forward Current T _c =125°C	I _{F(AV)}	1.2						A
Peak Forward Surge Current, 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	40						A
Maximum Instantaneous Forward Voltage @I _F =1.2A	V _F	1.1						V
Maximum DC Reverse Current T _A =25°C at Rated DC Blocking Voltage	I _R	5						μA
		80						
Typical Junction Capacitance ¹	C _J	18						pF
Thermal Resistance Junction-Ambient ²	R _{θJA}	75						°C/W
Thermal Resistance Junction-Case ²	R _{θJC}	22						
Operating & Storage Temperature Range	T _J , T _{STG}	-55~150						°C

Notes:

1. Measured at 1MHz and applied reverse voltage of 4V D.C.
2. The device is mounted on a glass epoxy PC board with a 4 x 1.5" x 1.5" (3.81 x 3.81cm) copper pad.

RATINGS AND CHARACTERISTIC CURVES

Fig.1 Average Rectified Output Current Derating Curve

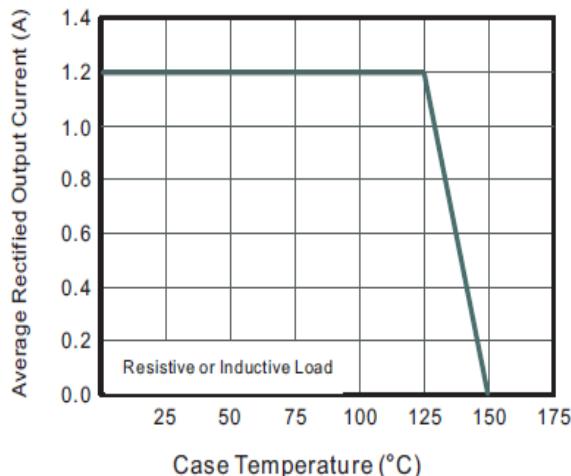


Fig.3 Typical Instantaneous Forward Characteristics

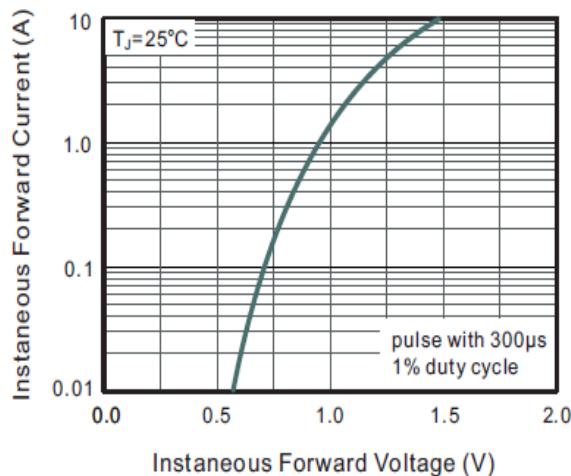


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

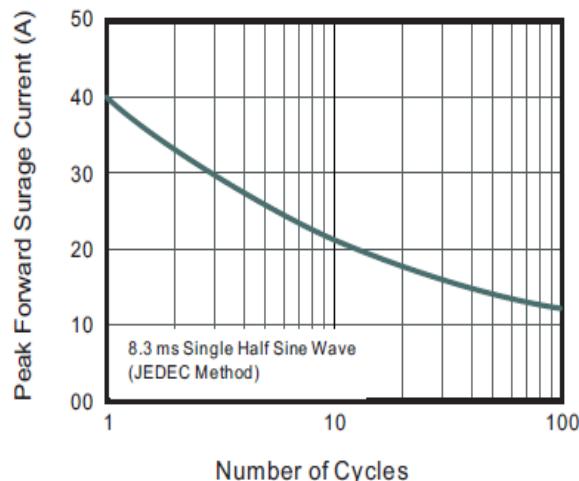


Fig.2 Typical Reverse Characteristics

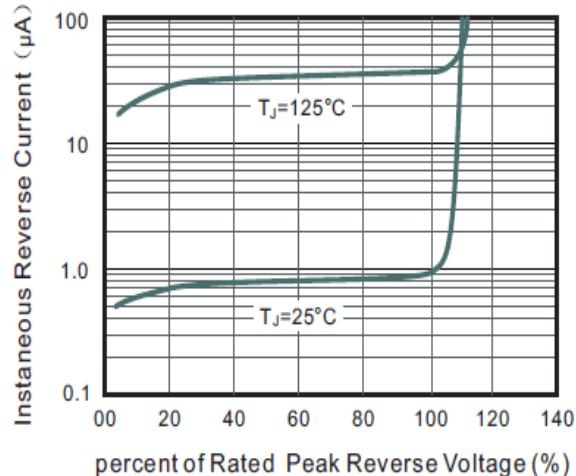


Fig.4 Typical Junction Capacitance

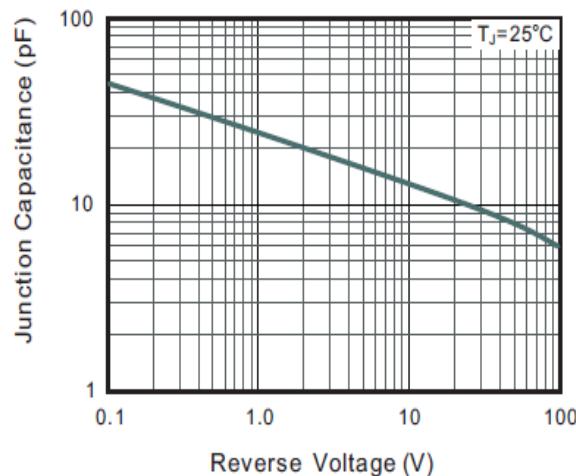
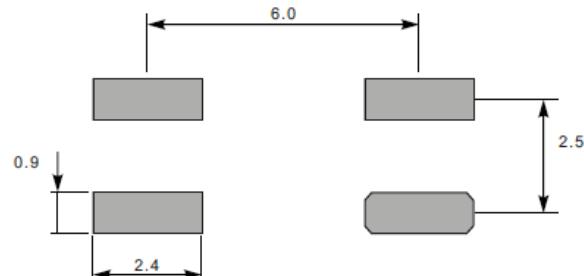


Fig.6 Mounting Pad Layout



*Dimensions in millimeters